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## 1A, 50V - 600V Surface Mount Ultrafast Power Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Ultrafast recovery time for high efficiency
- Low forward voltage, low power loss
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I <sub>F(AV)</sub>	1	Α			
$V_{RRM}$	50 - 600	>			
T <sub>J MAX</sub>	175	°C			
Package	DO-214AA (SMB)				
Configuration	Single Die				

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

#### **MECHANICAL DATA**

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Part no. with suffix "H" means AEC-Q101 qualified
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.09 g (approximately)





DO-214AA (SMB)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)								
PARAMETER	SYMBOL	MUR 105S	MUR 110S	MUR 115S	MUR 120S	MUR 140S	MUR 160S	UNIT
Marking code on the device		MUR 105S	MUR 110S	MUR 115S	MUR 120S	MUR 140S	MUR 160S	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	105	140	280	420	V
Maximum DC blocking voltage	$V_{DC}$	50	100	150	200	400	600	V
Forward current	I <sub>F(AV)</sub>	1			Α			
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	40 35		5	А			
Junction temperature	TJ	- 55 to +175			°C			
Storage temperature	T <sub>STG</sub>	- 55 to +175			°C			

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	17	°C/W

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
	MUR105S		V <sub>F</sub>	-	0.875	V
	MUR110S					V
Forward voltage per diode (1)	MUR115S	   I <sub>F</sub> = 1Α,Τ <sub>J</sub> = 25°C				V
i oiwaid voitage per diode	MUR120S	, , , , , , , , , , , , , , , , , , ,				V
	MUR140S			_	1.250	V
	MUR160S					V
	MUR105S					V
	MUR110S			-	0.710	V
Forward voltage per diode (1)	MUR115S	I <sub>F</sub> = 1A,T <sub>J</sub> = 150°C	$V_{F}$	-	1.050	V
•	MUR120S					V
	MUR140S MUR160S					V
		- - - T <sub>J</sub> = 25°C		-	2	
	MUR105S		I <sub>R</sub>			μΑ
	MUR110S					μA
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	MUR115S					μA
per diode 17	MUR120S					μA
	MUR140S					μA
	MUR160S					μA
	MUR105S		I <sub>R</sub>	-	50 150	μA
	MUR110S					μA
Reverse current @ rated V <sub>R</sub>	MUR115S	T <sub>J</sub> = 150°C				μA
per diode (2)	MUR120S					μA
	MUR140S					μA
	MUR160S					μA
	MUR105S		t <sub>rr</sub>	-	25	ns
	MUR110S					ns
D	MUR115S	I <sub>F</sub> =0.5A ,I <sub>R</sub> =1.0A				ns
Reverse recovery time	MUR120S	I <sub>RR</sub> =0.25A				ns
	MUR140S			-	50	ns
	MUR160S					ns

#### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms



## Taiwan Semiconductor

ORDERING INFORMATION							
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX(*)	PACKAGE	PACKING		
MUR1xxS (Note 1)		R5	Ð	SMB	850 / 7" Plastic reel		
	Н	R4		SMB	3,000 / 13" Paper reel		
(11010 1)		M4		SMB	3,000 / 13" Plastic reel		

## Note:

<sup>\*:</sup> Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
MUR160SHR5G	MUR160S	Н	R5	G	AEC-Q101 qualified Green compound

<sup>1. &</sup>quot;x" defines voltage from 50V (MUR105S) to 1000V (MUR160S)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig1. Forward Current Derating Curve

1.5 VERYARD CURRENT (°C)

Fig2. Typical Junction Capacitance

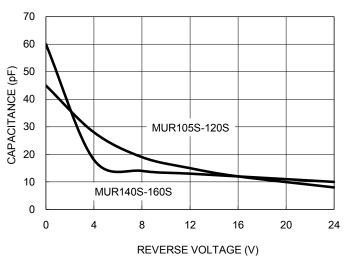


Fig3. Typical Reverse Characteristics

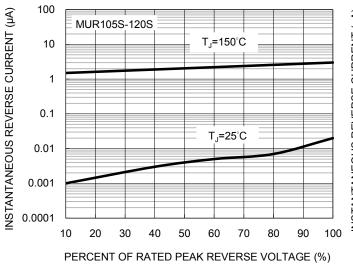
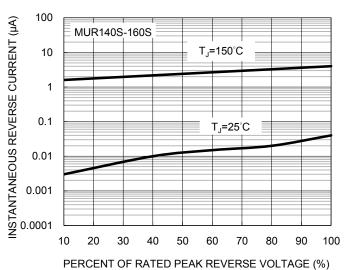


Fig4. Typical Reverse Characteristics



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Fig5. Typical Forward Characteristics

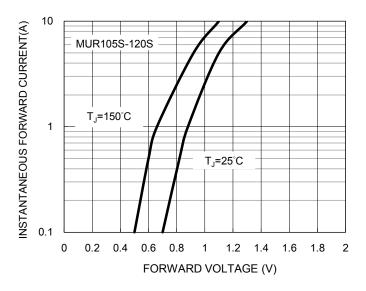


Fig6. Typical Forward Characteristics

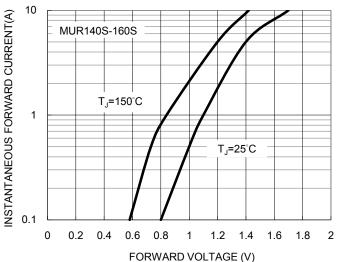
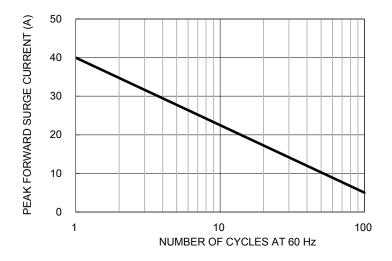


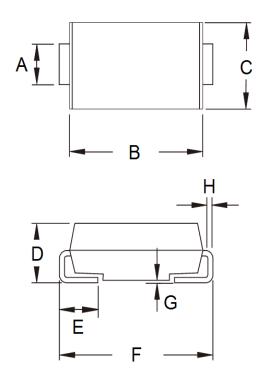
Fig5. Maximum Non-repetitive Forward Surge Current





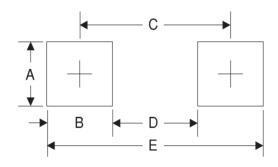
## **PACKAGE OUTLINE DIMENSIONS**

DO-214AA (SMB)



DIM.	Unit	(mm)	Unit (inch)		
DIWI.	Min	Max	Min	Max	
Α	1.95	2.20	0.077	0.087	
В	4.05	4.60	0.159	0.181	
С	3.30	3.95	0.130	0.156	
D	1.95	2.65	0.077	0.104	
Е	0.75	1.60	0.030	0.063	
F	5.10	5.60	0.201	0.220	
G	0.05	0.20	0.002	0.008	
Н	0.15	0.31	0.006	0.012	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	2.3	0.091
В	2.5	0.098
С	4.3	0.169
D	1.8	0.071
Е	6.8	0.268

#### **MARKING DIAGRAM**



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code



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